



March 2001

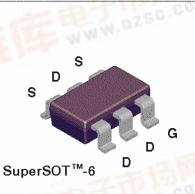
# SI3442DV N-Channel Logic Level Enhancement Mode Field Effect Transistor

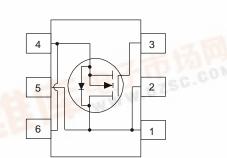
### **General Description**

These N-Channel logic level enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications in notebook computers, portable phones, PCMICA cards, and other battery powered circuits where fast switching, and low in-line power loss are needed in a very small outline surface mount package.

### Features

- 4.1 A, 20 V.  $R_{DS(ON)} = 0.06 \ \Omega \ @ V_{GS} = 4.5 \ V$  $R_{DS(ON)} = 0.075 \ \Omega \ @ V_{GS} = 2.7 \ V.$
- Proprietary SuperSOT<sup>™</sup>-6 package design using copper lead frame for superior thermal and electrical capabilities.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- Exceptional on-resistance and maximum DC current capability.

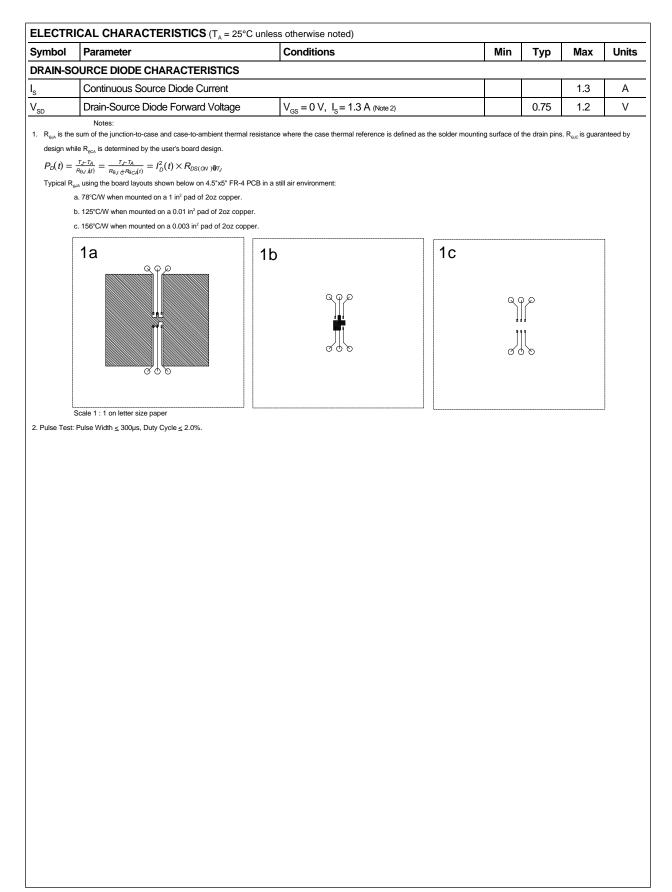


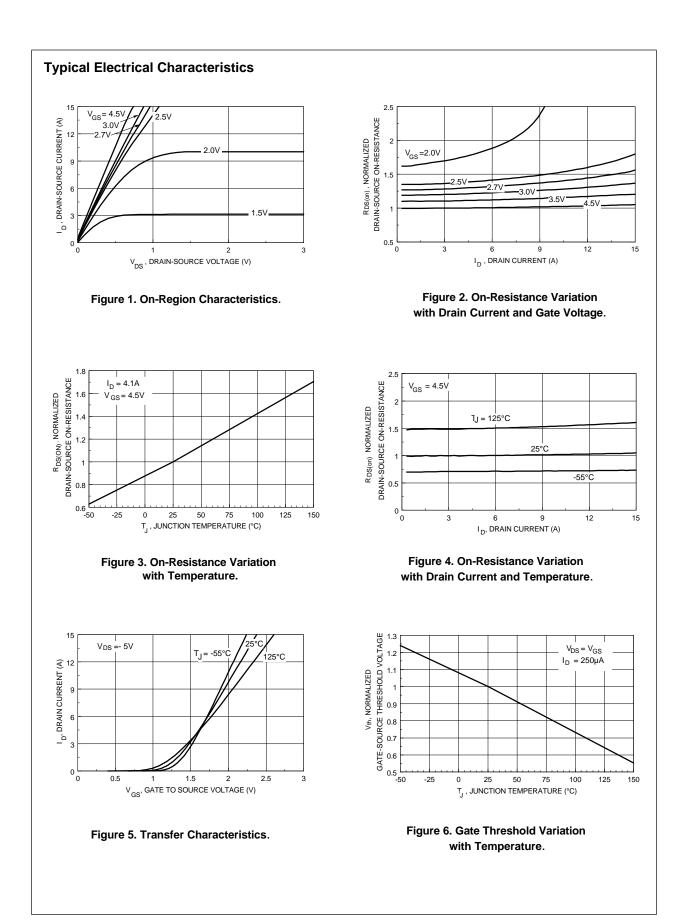


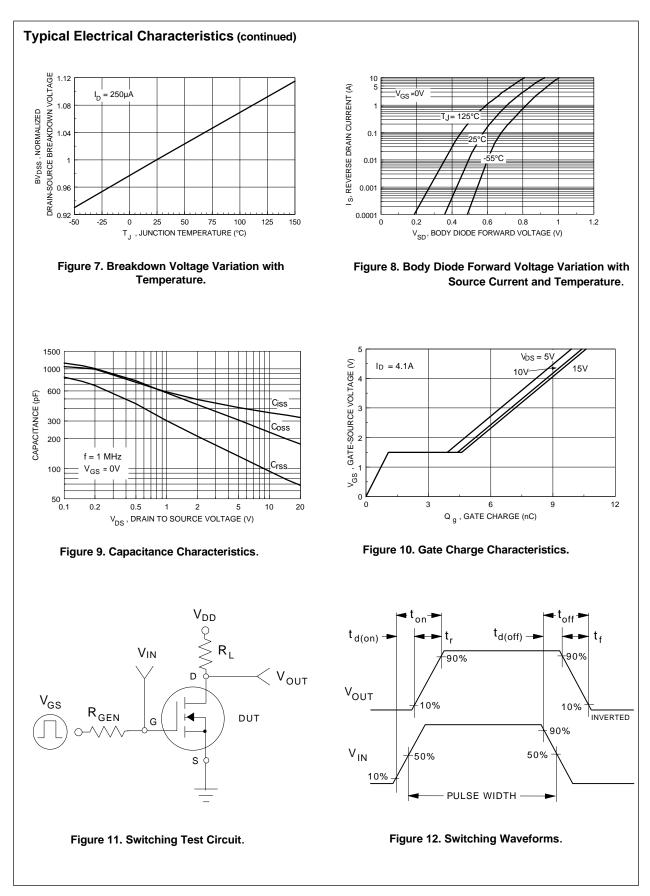
## **Absolute Maximum Ratings** $T_A = 25^{\circ}C$ unless otherwise note

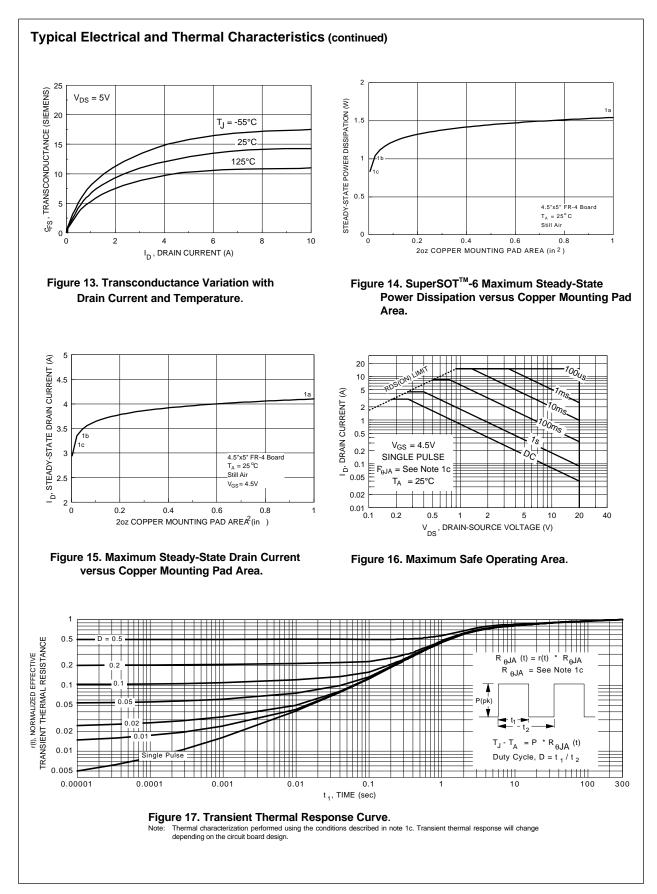
Symbol	Parameter		SI3442DV	
V <sub>DSS</sub>	Drain-Source Voltage		20	V
V <sub>GSS</sub>	Gate-Source Voltage - Continuous		8	V
I <sub>D</sub>	Drain Current - Continuous	(Note 1a)	4.1	А
	- Pulsed		15	
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	1.6	W
		(Note 1b)	1	
	571	(Note 1c)	0.8	
T_J,T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	AL CHARACTERISTICS			
R <sub>øJA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1a)		78	
R <sub>ØJC</sub>	Thermal Resistance, Junction-to-Cas	Se (Note 1)	30	°C/W

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
			T <sub>J</sub> = 55°C			10	μA
	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$				100	nA
	Gate - Body Leakage, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$				-100	nA
ON CHAI	RACTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		0.4	0.7	1	V
00(0)			T <sub>J</sub> = 125°C	0.3	0.5	0.8	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 4.1 \text{ A}$	·		0.039	0.06	Ω
			T <sub>J</sub> = 125°C		0.06	0.11	
		$V_{GS} = 2.7 \text{ V}, I_D = 3.6 \text{ A}$			0.05	0.075	
D(on)	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$		15			Α
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 4.5 \text{ V}, I_{D} = 4.1 \text{ A}$			12		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 \text{ V},  V_{GS} = 0 \text{ V},$ f = 1.0 MHz			365		pF
C <sub>oss</sub>	Output Capacitance				230		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				95		pF
SWITCHI	NG CHARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GEN} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			9	17	ns
ţ	Turn - On Rise Time				25	45	ns
t <sub>D(off)</sub>	Turn - Off Delay Time				28	50	ns
t,	Turn - Off Fall Time				8	15	ns
Q <sub>g</sub>	Total Gate Charge	$V_{\rm DS} = 10  \rm V,$			10	14	nC
$Q_{gs}$	Gate-Source Charge	$I_{\rm D} = 4.1  \text{A},  V_{\rm GS} = 4.5  \text{V}$			1		nC
$Q_{gd}$	Gate-Drain Charge				3.3		nC









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